Electron-phonon interaction via Pekar mechanism in nanostructures

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Abstract

We consider an electron-acoustic phonon coupling mechanism associated with the dependence of crystal dielectric permittivity on the strain (the so-called Pekar mechanism) in nanostructures characterized by strong con ning electric elds. The electric of Pekar coupling is a function of both the absolute value and the spatial distribution of the electric eld. It is demonstrated that this mechanism exhibits a phonon wavevector dependence similar to that of piezoelectricity and must be taken into account for electron transport calculations in an extended eld distribution. In particular, we analyze the role of Pekar coupling in energy relaxation in silicon inversion layers. Comparison with the recent experimental results is provided to illustrate its potential signicance.

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The electron-phonon interaction is one of the fundam ental problems in solid-state physics. For coupling with acoustic phonons in particular, much attention has been devoted to the two main mechanisms in semiconductors: the deformation potential and piezoelectric interaction. In the presence of an external electric eld E, however, an additional process appears associated with the dependence of dielectric permittivity on the strain. Due to this dependence, an acoustic phonon can induce an electric eld component and subsequently an additional coupling with electrons. This mechanism was initially introduced by Pekar [1, 2] for the problem of sound amplication by drifting electrons. It was shown later [3] that the Pekar mechanism of electron-phonon interaction is related directly to the electrostriction electronection electronection are extincted as a piezo-like dependence on the phonon wavevector q and can roughly be characterized by an electronection.

$$_{\text{eff}}$$
 $^{\text{\'e}}$ Ep; (1)

where p is the photoelasticity constant and " is the dielectric perm ittivity of the unstrained crystal. In ordinary bulk crystals with E $^{<}$ 10^4 V=cm , $_{\rm eff}$ is quite sm all. As a result, Pekar initially concentrated on the materials with a very large " (e.g., " 2000 for BaT iO₃) and electrostriction e ect. E cient acousto-electric coupling for such materials was observed experimentally in the seventies [4].

As the dimension of the sample structure shrinks, interaction mechanisms that are not allowed in bulk materials can manifest them selves. For instance, modulation of the quantum well width and electrice mass by strain gives rise to the so-called macroscopic deformation potential [5]. Similarly, the "traditional" mechanisms can exhibit dierent features. In this paper, we demonstrate that the Pekar mechanism is essential for nanostructures with strong con ning electric elds [6, 7]. The interaction eldercy is dependent on the spatial scale of the electric eld localization and the phonon wavelength. As a special example, we consider low-temperature electron energy relaxation in n-type (100) Si inversion layers. Our calculation shows that due to the Pekar mechanism, the dissipated power in these non-piezoelectric materials can exhibit a piezo-like T³ dependence. This inding provides a clear explanation for a recent experimental observation of similar dependence [8].

Let us start with a general analysis of the Pekarm echanism for the case of a nonuniform electric eld distribution. The variation of dielectric perm ittivity under strain u_{ij} can be

written in the form [9]:

$$\mathbf{u}_{ij} = \mathbf{u}_{ij}^2 p_{ik lm} u_{lm} ;$$
 (2)

where p_{iklm} is the photoelasticity tensor (we could use the electrostriction tensor instead; however, the use of photoelasticity tensor allows one to extract explicitly the dependence of electrostriction on ", which follows from the Clausius (Mossottim odel [10]). The form of photoelasticity tensor is determined by the symmetry of the crystal. In the diamond and zinc-blende structures, there are only three independent nonzero components of this tensor denoted usually as p_{11} , p_{12} , and p_{44} [9]. Moreover, " $_{ij} = _{ij}$ ".

The electrostriction e ect in a static external eld E leads to appearance of an e ective eld $E' = r^{\sim}$. The equation for potential \sim can be derived from the equation for the electric displacement D:

r D = 0;
$$p = "_{ij}E_k^{()};$$
 (3)

where $E^{()} = E + E^{\sim}$ is the total electric eld in the crystal. Assuming that the strain is small, we obtain

$$r^2 \sim = \frac{1}{"} \frac{0}{0 x_i} ("_{ik} E_k)$$
: (4)

In the simplest situation, the external electric eld is E = (0;0;E(z)), which corresponds to the conning eld in a quantum well. We also assume an elastically uniform medium with the functional dependence of u_{ij} ; $u_{ij} = \exp[i(\cdot !t + \varphi z + q_{jj})]$ and $u_{ij} = u_{ij} = u_$

$$\frac{d^{2}}{dz^{2}} \qquad \hat{q}_{\underline{j}}^{2} = G(z); G(z) \qquad E(z) \frac{\theta_{\underline{j}z}}{\theta_{\underline{x}_{\underline{i}}}} + \frac{u_{zz}}{dz} \frac{dE(z)}{dz} \frac{1}{u}; \tag{5}$$

resulting in

$$\sim = \frac{1}{2q_{k}} e^{q_{k}z} \int_{z}^{z} G(z^{0}) e^{-q_{k}z^{0}} dz^{0} = \frac{1}{2q_{k}} e^{-q_{k}z} \int_{z}^{z} G(z^{0}) e^{q_{k}z^{0}} dz^{0};$$
 (6)

It is important to note two important features of $\tilde{}$. First, $\tilde{}$ is not a plane wave as a function of z, which is a direct result of the assumed nonuniform character of the electric eld. Second, $\tilde{}$ strongly depends on the spatial domain of electric eld localization, d. For $q_z d$ 1 and $q_{\bar{1}} d$ 1, the estimate of Eq. (1) applies. For $q_z d$ 1 and $q_{\bar{1}} d$ 1, however, the induced potential is suppressed substantially with a factor q d.

Let us consider a speci c example, namely, the process of energy relaxation in n-type (100) Si inversion layers at low temperatures. The built—in conning electric elds in such structures can be as high as several MV=cm. In this case, the role of Pekar mechanism is particularly important since silicon itself is not a piezoelectric material and the Pekar contribution is expected to be dominant at low temperatures, where the deformation potential interaction is less elective. Of course, the Pekar mechanism also provides a contribution to the momentum relaxation rate that determines the mobility. However, at low temperatures the momentum relaxes mainly due to the elastic scattering by various imperfections, and the contribution of phonons is hardly measurable. Thus, we concentrate on energy relaxation.

The electron potential well near the Si/SiO_2 interface and the electric eld associated with the inversion layer are shown schematically in Fig. 1. The strong static electric eld E = d(z)=dz associated with the inversion layer connest he electrons in a thin silicon layer near the interface. The electrostatic potential (z), quantized electron levels and wavefunctions $(r) = (z) \exp(ik\%)$ are determined from the self-consistent solution of Poisson and Schrödinger equations [6]. In the following, we assume that only the ground electron subband is populated at low temperatures.

The induced potential is determined by Eq. (5). The boundary conditions at the Si/SiO $_2$ interface (z = 0) under a small strain are:

$$^{\sim (s)} = ^{\sim (ins)}; \quad ^{"(s)}E_{z}^{(s)} + \quad ^{"(s)}z_{z}E^{(s)} = ^{"(ins)}E_{z}^{(ins)} + \quad ^{"(ins)}z_{z}E^{(ins)};$$
 (7)

where $E_z = d = dz$. For the considered geometry, the following photoelasticity terms are relevant:

$$\mathbf{u}_{xz} = 2^{\mathbf{u}^{2}} p_{44} u_{xz};$$

$$\mathbf{u}_{yz} = 2^{\mathbf{u}^{2}} p_{44} u_{yz};$$

$$\mathbf{u}_{zz} = \mathbf{u}^{2} (p_{11} u_{zz} + p_{12} (u_{yy} + u_{xx}));$$
(8)

where x;y;z are the sym m etry axis of the crystal. For sim plicity, we disregard the m ism atch of elastic and photoelasticity constants in Si and SiO₂ layers. We also assume that the actual phonon wavelength exceeds the thickness of the depletion layer in silicon (see Fig. 1) and yet is much less than the thickness of the SiO₂ layer. The former assumption can be justified at low enough temperatures, where the contribution of the Pekar mechanism exceeds that of the deformation potential. In case when the latter condition is violated, the induced

potential becomes weak in accordance with the general analysis given above. In fact, this restricts the parameters of actual structures where the Pekar mechanism is important.

Under these assumptions, R dz 2 (z) $^{\sim}$ (0), leading to

$$^{\sim}(0) = \frac{\mathbf{u}_{(s)} \mathbf{u}_{(ins)}}{\mathbf{u}_{(s)} + \mathbf{u}_{(ins)}} \frac{\mathbf{E}_{s}}{\mathbf{q}_{ij} + i\mathbf{q}_{z}} \quad (p_{44}\mathbf{q}_{jj} + i\mathbf{q}_{z}p_{11})\mathbf{u}_{z} + p_{44}\frac{\mathbf{q}_{z}}{\mathbf{q}_{ij}} + i\mathbf{p}_{12} \quad (\mathbf{u}_{s}\mathbf{q}_{jj}) : \tag{9}$$

Here, E_s and u_s are the electric eld and the phonon displacem ent at the silicon side of the interface, respectively.

Using Eq. (9), we calculate the electron scattering rates $W_{kk}^{q_2}$ for electron transition $k \,!\, k^0$ with absorption (+) or em ission () of an acoustic phonon:

where $_k$ is the electron energy and N $_q$ represents the P lanck population of the phonon m odes characterized by the lattice tem perature T . The index lofthe function j $_1$ () jdenotes the type of the phonon m odes. In particular,

$$j_{LA}()^{2} = p_{11}^{2} + (4p_{44}^{2} + 2p_{11}p_{12})\sin^{2} + (p_{11}^{2} + p_{12}^{2} + 2p_{11}p_{12})\sin^{4} + (p_{11}^{2} + p_{12}^{2} + 2p_{11}p_{12})\sin^{4}$$
(11)

$$j_{TA}()^2 = p_{44}^2 (\sin^2 \cos^2 t^2 + (p_{11} p_{21})^2 \sin^2 \cos^2 t^2$$
 (12)

where is the angle between the phonon wave vector q and the z axis, V and are the normalizing volume and density, respectively, and $!_q = s_{l,t}q$ is the phonon frequency. TA corresponds to the contribution of the transverse phonons w ith a vertical polarization (u lies in the plane formed by the z axis and q); the contribution of the phonons w ith a horizontal polarization (u is parallel to the interface) is zero. The power Q dissipated by electrons is given as [11]:

$$Q = gS^{-1}_{k;k^0;q_z} (_k _{k^0}) (W_{kk^0}^{q_z;+} + W_{kk^0}^{(q_z;-)}) f_{T_e} (k) (1 f_{T_e}(k^0));$$
(13)

where g is the electron degeneracy (g = 4 in a (100) inversion layer taking into account both the spin and valley degeneracy) and S is the cross sectional area for normalization. In the expression for Q, we assume that the electron-electron interaction establishes a Fermi distribution for electrons with an electron temperature $T_{\rm e}$.

At a low tem perature, the small-angle (B loch-G runizen) scattering regime is realized. For degenerate electrons after the standard transformations, we obtain a piezo-like tem perature

dependence:

$$Q = C \left(T_{e}^{3} \quad T^{3}\right);$$

$$C = \left(C_{LA} + C_{TA}\right) \frac{1}{7-2} \frac{m^{2} \left(E_{s}\right)^{2}}{h^{5} n_{e}^{1-2}} \frac{e^{2}}{3} \quad (3) \quad \frac{\mathbf{u}(s) \mathbf{u}(\ln s)}{\mathbf{u}(s) + \mathbf{u}(\ln s)};$$

$$C_{LA} = \frac{1}{s_{1}^{2}} \frac{1}{8} 4p_{44}^{2} + 2p_{11}p_{12} + 3p_{11}^{2} + 3p_{12}^{2};$$

$$C_{TA} = \frac{1}{s_{1}^{2}} \frac{1}{8} 4p_{44}^{2} + \left(p_{11} \quad p_{12}\right)^{2};$$

$$(14)$$

where m is the electron electron electron ass for the in-plane motion, n_e is the electron concentration in the inversion layer, and is the Riemann zeta-function, (3) 120.

For a numerical estimation, we use the following material parameters: " $_{\text{Si}} = 12$, = 2 g=cm^3 , " $_{\text{SiO}_2} = 4$, $s_1 = 9$ $10^6 \text{ cm} = s$, $s_t = 5.4$ $10^6 \text{ cm} = s$, and m = 0.19m_0 [for the (100) interface]. The values of the photoelasticity tensor are $p_{11} = 0.093$, $p_{22} = 0.026$, and $p_{44} = 0.05$ [12]. As mentioned previously, the electron density and electric eld at the interface must be determined by a self-consistent procedure. As a rough estimate, we adopt $E_s = 3$ 10^6 V=cm and $n_e = 5$ 10^{11} cm^{-2} , which provide $C = 10^{-4} \text{ W} = \text{K}^{-3} \text{m}^{-2}$. This corresponds to the energy relaxation time of about 1 ms at the electron temperature of $T_e = 1 \text{ K}$ and $T_e = 1 \text$

In a recent experiment on silicon metal-oxide-sem iconductor eld-e ect transistors [8], the cubic dependence of Q on T_e was observed at low temperatures, which was followed by a T_e^5 dependence for $T_e > 0$:6 K characteristic for the deformation potential coupling. The authors of Ref. 8 attributed the T_e^3 dependence to the appearance of e ective piezoelectric properties due to the speci c structure of the interface. Indeed, the interface reduces the symmetry of the system which can give rise to nonzero piezoelectricity in the vicinity of interface. However, for the phonon wavelength exceeding the thickness of this "piezoelectric" layer, the piezoelectric potential induced by the phonon is suppressed (this is similar to the case of the Pekar potential for narrow regions of electric eld localization). Therefore, the observed cubic dependence is more likely to be due to the Pekar mechanism. Note also, that the obtained above value of C is close to that measured experimentally [8].

In sum mary, we show that the Pekar mechanism of electron-phonon interaction (related to the electrostriction e ect) can become important in nanostructures due to the presence of strong con ning electric elds and must be considered along with the deformation potential and piezoelectric mechanisms. The electrices of Pekar coupling depends on both the

FIG.1: (a) Schematic illustration of the potential well in a n-type Si inversion layer. The thickness of the depletion layer is denoted by d_{depl} . (b) z-dependence of the conning electricellayer.

absolute value and the spatial distribution of the electric eld. An estimation of power dissipation by this mechanism in a silicon inversion layer is in good agreement with a recent experiment.

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